

40 V, N-channel Trench MOSFET

9 May 2019

1. General description

N-channel enhancement mode Field-Effect Transistor (FET) in a small SOT23 (TO-236AB) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

2. Features and benefits

- Logic-level compatible
- Extended temperature range T_i = 175 °C
- Trench MOSFET technology
- ElectroStatic Discharge (ESD) protection > 1.5 kV HBM (class H1C)
- AEC-Q101 qualified

3. Applications

- Relay driver
- High-speed line driver
- Low-side load switch
- Switching circuits

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{DS}	drain-source voltage	T _j = 25 °C		-	-	40	V
V _{GS}	gate-source voltage			-20	-	20	V
I _D	drain current	V _{GS} = 10 V; T _{amb} = 25 °C	[1]	-	-	3	А
Static chara	octeristics						
R _{DSon}	drain-source on-state resistance	V _{GS} = 10 V; I _D = 3 A; T _j = 25 °C		-	60	75	mΩ

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm².

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5. Pinning information

Table 2. Pinning information							
Pin	Symbol	Description	Simplified outline	Graphic symbol			
1	G	gate	3	D			
2	S	source					
3	D	drain	1 2 TO-236AB (SOT23)	G G S 017aaa255			

6. Ordering information

Table 3. Ordering information						
Type number	Package					
	Name	Description	Version			
PMV60ENEA	TO-236AB	plastic surface-mounted package; 3 leads	SOT23			

7. Marking

Table 4. Marking codes

Type number	Marking code[1]
PMV60ENEA	HR%

[1] % = placeholder for manufacturing site code

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8. Limiting values

Table 5. Limiting values

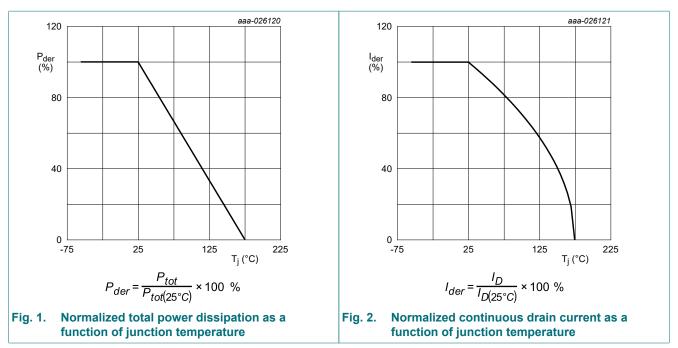
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{DS}	drain-source voltage	T _j = 25 °C		-	40	V
V _{GS}	gate-source voltage			-20	20	V
I _D	drain current	V _{GS} = 10 V; T _{amb} = 25 °C	[1]	-	3	А
		V _{GS} = 10 V; T _{amb} = 100 °C	[1]	-	2.1	А
I _{DM}	peak drain current	T_{amb} = 25 °C; single pulse; $t_p \le 10 \ \mu s$		-	12	А
P _{tot}	total power dissipation	T _{amb} = 25 °C	[2]	-	615	mW
			[1]	-	1.25	W
		T _{sp} = 25 °C		-	7.5	W
Tj	junction temperature			-55	175	°C
T _{amb}	ambient temperature			-55	175	°C
T _{stg}	storage temperature			-65	175	°C
Source-draiı	n diode			I		
Is	source current	T _{amb} = 25 °C	[1]	-	1.3	А
ESD maximu	um rating			I		
V _{ESD}	electrostatic discharge voltage	НВМ	[3]	-	1500	V
Avalanche r	uggedness					
E _{DS(AL)S}	non-repetitive drain- source avalanche energy	T _{j(init)} = 25 °C; I _D = 0.42 A; DUT in avalanche (unclamped)		-	8.5	mJ
						_

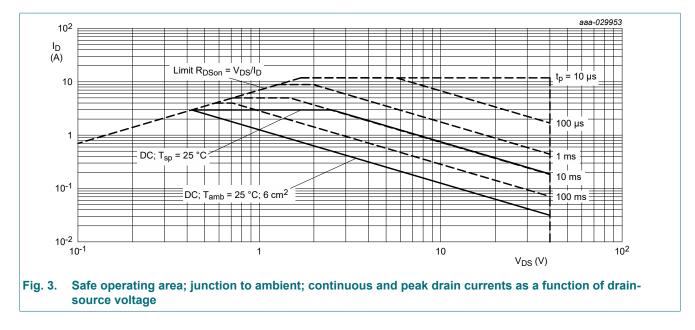
[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and mounting pad for drain 6 cm².

[2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[3] Measured between all pins.



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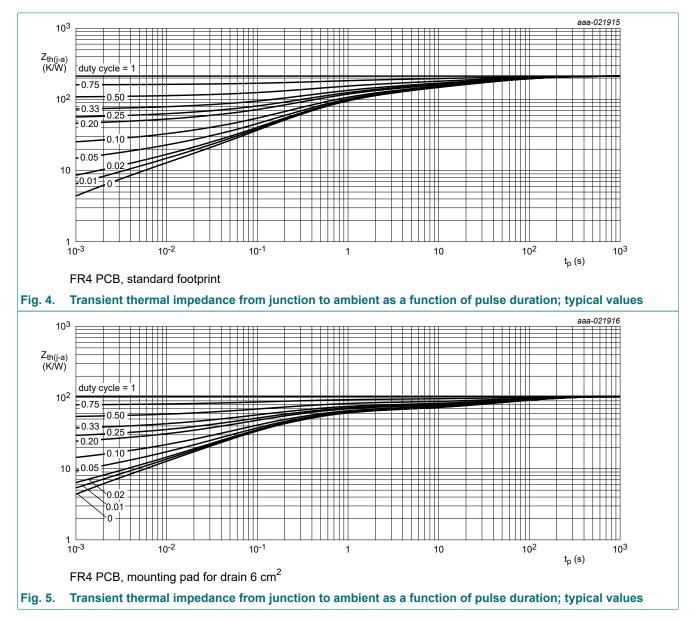


9. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
R _{th(j-a)} thermal resistance fror	in free air	[1]	-	212	244	K/W	
	junction to ambient		[2]	-	104	119	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point			-	17	20	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

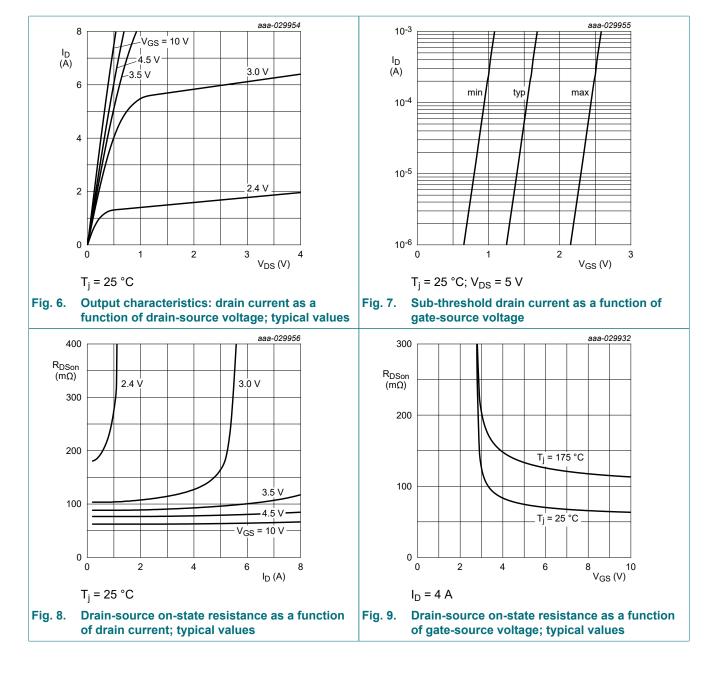
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and mounting pad for drain 6 cm².



10. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	octeristics					
V _{(BR)DSS}	drain-source breakdown voltage	$I_D = 250 \ \mu\text{A}; \ V_{GS} = 0 \ V; \ T_j = 25 \ ^\circ\text{C}$	40	-	-	V
V _{GSth}	gate-source threshold voltage	I _D = 250 μA; V _{DS} = V _{GS} ; T _j = 25 °C	1	1.6	2.5	V
I _{DSS}	drain leakage current	V _{DS} = 40 V; V _{GS} = 0 V; T _j = 25 °C	-	-	1	μA
I _{GSS}	gate leakage current	V _{GS} = 20 V; V _{DS} = 0 V; T _j = 25 °C	-	-	10	μA
		V _{GS} = -20 V; V _{DS} = 0 V; T _j = 25 °C	-	-	-10	μA
		V _{GS} = 10 V; V _{DS} = 0 V; T _j = 25 °C	-	-	2	μA
		V _{GS} = -10 V; V _{DS} = 0 V; T _j = 25 °C	-	-	-2	μA
R _{DSon}	drain-source on-state	V _{GS} = 10 V; I _D = 3 A; T _j = 25 °C	-	60	75	mΩ
	resistance	V _{GS} = 10 V; I _D = 3 A; T _j = 175 °C	-	114	143	mΩ
		V _{GS} = 4.5 V; I _D = 2.6 A; T _j = 25 °C	-	75	99	mΩ
9 _{fs}	forward transconductance	V _{DS} = 10 V; I _D = 3 A; T _j = 25 °C	-	5.3	-	S
R _G	gate resistance	f = 1 MHz	-	2	-	Ω
Dynamic ch	aracteristics	1	I			
Q _{G(tot)}	total gate charge	V_{DS} = 20 V; I _D = 3 A; V _{GS} = 10 V;	-	3.6	5	nC
Q _{GS}	gate-source charge	T _j = 25 °C	-	0.5	-	nC
Q _{GD}	gate-drain charge		-	0.8	-	nC
C _{iss}	input capacitance	V _{DS} = 20 V; f = 1 MHz; V _{GS} = 0 V;	-	180	-	pF
C _{oss}	output capacitance	T _j = 25 °C	-	36	-	pF
C _{rss}	reverse transfer capacitance		-	21	-	pF
t _{d(on)}	turn-on delay time	V_{DS} = 20 V; I _D = 3 A; V _{GS} = 10 V;	-	3	-	ns
t _r	rise time	R _{G(ext)} = 6 Ω; T _j = 25 °C	-	10	-	ns
t _{d(off)}	turn-off delay time		-	8	-	ns
t _f	fall time		-	3	-	ns
Source-drai	n diode	· · ·	1			
V _{SD}	source-drain voltage	I _S = 1.3 A; V _{GS} = 0 V; T _j = 25 °C	-	0.8	1.2	V
t _{rr}	reverse recovery time	I _S = 0.9 A; dI _S /dt = -100 A/μs;	-	8	-	ns
Q _r	recovered charge	V _{GS} = 0 V; V _{DS} = 20 V; T _j = 25 °C	-	2	-	nC

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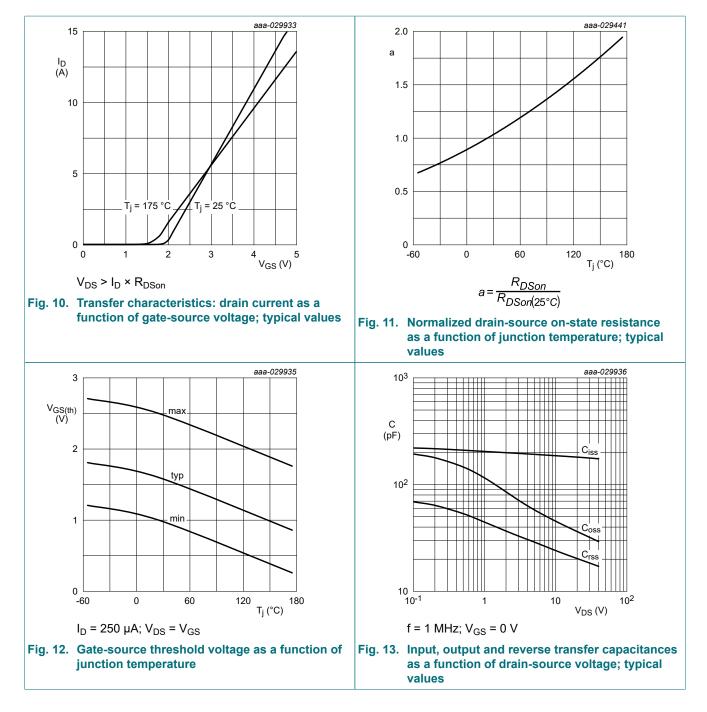


Product data sheet

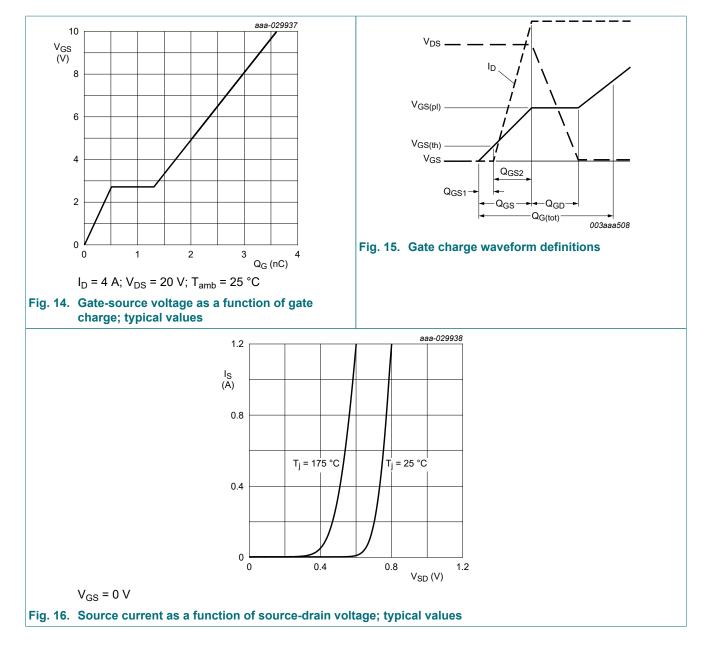
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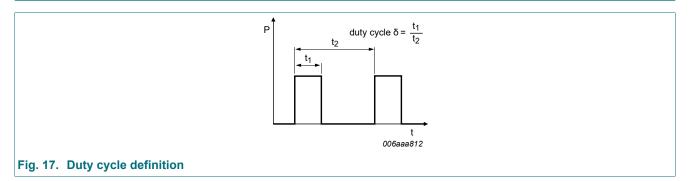
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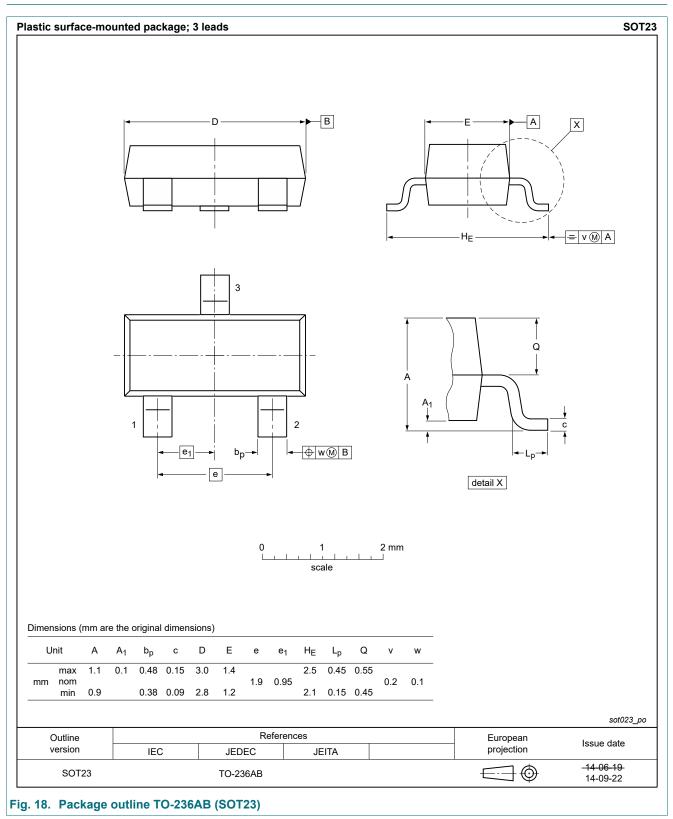
11. Test information



Quality information

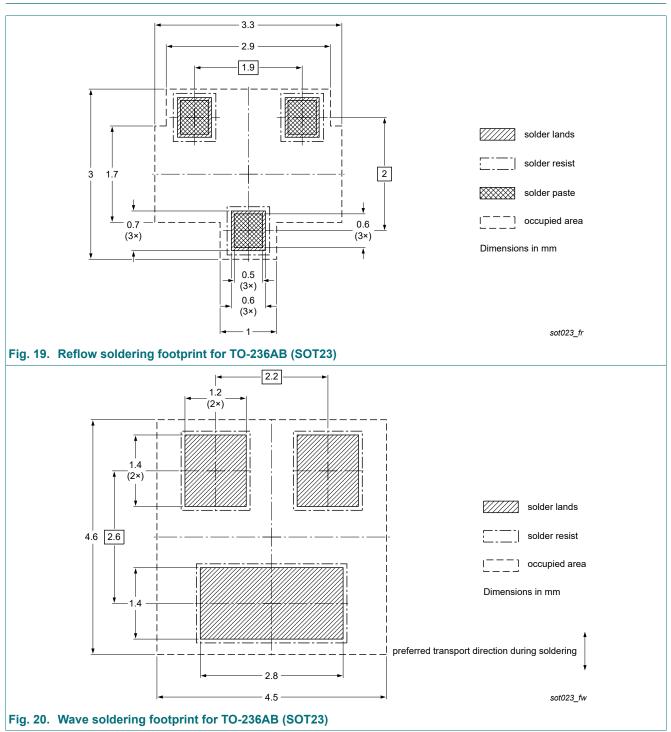
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

12. Package outline



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13. Soldering



14. Revision history

Table 8. Revision history						
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes		
PMV60ENEA v.1	20190509	Product data sheet	-	-		

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

 Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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